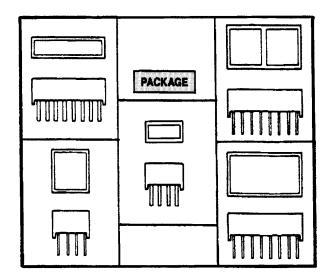


HIGH EFFICIENCY RED HLMP-2300/2600 SERIES YELLOW HLMP-2400/2700 SERIES HIGH EFFICIENCY GREEN HLMP-2500/2800 SERIES



DESCRIPTION

These LED Light Bar series are bright, large emitting area, rectangular devices that are designed for backlighting legend/message annunciators.

These devices are offered in single-in-line and dual-in-line packages that contain single or segmented light-emitting area. Each package style is offered in High Efficiency Red, Yellow, or Green emission color.

FEATURES

- Large area, uniform, bright light-emitting surfaces
- Select from six package styles
- Choice of three colors
- Categorized for intensity and color
- X-Y stackable
- Easily driven with I.C.s
- Alternate source for popular backlighting components

MODEL	NUMBERS			
PART NO.	COLOR	DESCRIPTION	PACKAGE	PIN OUT
HLMP-2300 HLMP-2400 HLMP-2500	High Efficiency Red Yellow High Efficiency Green	2 LED Single-in-line 0.35 in.×0.15 in. Area	Α	Α
HLMP-2350 HLMP-2450 HLMP-2550	High Efficiency Red Yellow High Efficiency Green	4 LED Single-in-line 0.75 in.×0.15 in. Area	В	В
HLMP-2655 HLMP-2755 HLMP-2855	High Efficiency Red Yellow High Efficiency Green	4 LED Dual-in-line 0.35 in.×0.35 in. Area	С	С
HLMP-2670 HLMP-2770 HLMP-2870	High Efficiency Red Yellow High Efficiency Green	Dual 0.35 in. ×0.35 in. Area Dual-in-line package	D	D
HLMP-2685 HLMP-2785 HLMP-2885	High Efficiency Red Yellow High Efficiency Green	8 LED 0.35 in.×0.75 in. Area Dual-in-line package	E	D

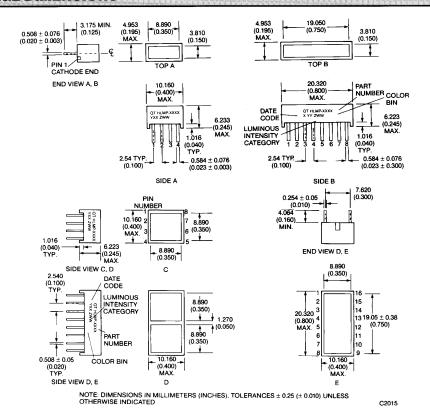


ABSOLUTE MAXIMUM RATINGS TA=25°C (Univ	·	
	HIGH EFFICIENCY RED HIGH EFFICIENCY GREEN HLMP-2300/-2500 -2600/-2800 SERIES	YELLOW HLMP-2400/ -2700 SERIES
Power dissipation per LED chip (See Note 1)	135 mW	85 mW
Peak forward current per LED chip,		
T _A =50°C (max. pulse width=2 ms) (See Notes 1 and 2)	90 mA	60 mA
Average forward per LED chip pulsed conditions,		
T _A =50°C (See Note 2)	25 m A	20 mA
DC forward current per LED chip,		
T _A =50°C (See Note 3)	30 mA	25 mA
Reverse voltage per LÉD chip	6V	6V
Storage and operating temperature range	-40°C to +85°C	-40°C to +85°C
Soldering time at 260°C (See Note 4)	260°C for 3 sec.	260°C for 3 sec.

NOTES

- For HLMP-2300/-2500/-2600/-2800 Series, derate above T_A=25°C at 1.8 mW/°C per LED chip. For HLMP-2400/-2700 Series, derate above T_A=50°C at 1.8 mW/°C per LED chip.
- 2. See Figure 1/2 to establish pulse operating conditions.
- For HLMP-2300/-2500/-2600/-2800 Series, derate above T_A=50°C at 0.5 mA/°C per LED chip. For HLMP-2400/-2700 Series derate above T_A=60°C at 9.5 mA/°C per LED chip.
- 4. Lead immersed to 1/16 in. from body of the device. Maximum unit surface temperature is 140°C.

PACKAGE DIMENSIONS





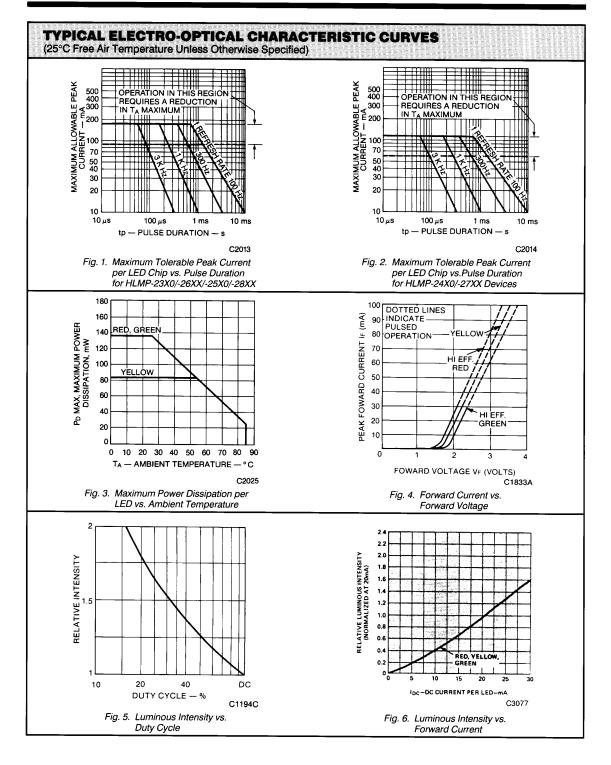


			HLMP						TEST
PARAMETER		SYMBOL	-2300	-2350	-2655	-2670	-2685	UNIT	CONDITIONS
Luminous	min.		6.0	13	13	13	22	mcd	I _F =20 mA
Intensity	typ.	l _v	23	45	43	45	80	mcd	$I_F=20 \text{ mA}$
intensity	typ.		30	50	50	50	100	mcd	I _F =60 mA pK, 1:3 D.F.
Forward	max.	$V_{\scriptscriptstyle F}$	2.6	2.6	2.6	2.6	2.6	٧	I _c =20 mA
voltage	typ.	VF	2.0	2.0	2.0	2.0	2.0	V	I _F =20 IIIA
Peak wavelength	typ.	λ_{p}	630	630	630	630	630	nm	
Dominant wavelength	typ.	λ_{d}	626	626	626	626	626	nm	
Capacitance	typ.	С	45	45	45	45	45	pF	$V_F=0$, $f=1$ MHz
Reverse voltage	min.	V_{R}	6	6	6	6	6	V	I_R =100 μ A
Thermal resistance	typ.	Θ_{JL}	150	150	150	150	150	°C/W/ LED chip	

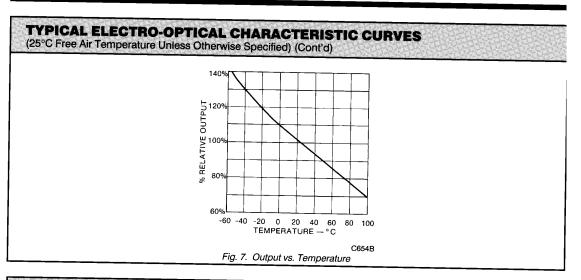
					HLMP		TEST		
PARAMETER		SYMBOL	-2400	-2450	-2755	-2770	-2785	UNIT	CONDITIONS
Luminous	min.		6	13	13	13	26	mcd	I _F =20 mA
Intensity	typ.	Ι _ν	20	38	35	35	70	mcd	I _F =20 mA
intensity	typ.		33	60	60	60	115	mcd	I _F =60 mA pK, 1:3 D.F.
Forward	max.	$V_{\scriptscriptstyle F}$	2.6	2.6	2.6	2.6	2.6	٧	I₅=20 mA
voltage	typ.	V _F	2.1	2.1	2.1	2.1	2.1	V	I _F =20 mA
Peak wavelength	typ.	$\lambda_{_{P}}$	585	585	585	585	585	nm	
Dominant wavelength	typ.	$\lambda_{\scriptscriptstyle d}$	588	588	588	588	588	nm	
Capacitance	typ.	С	35	35	35	35	35	pF	$V_F=0$, $f=1$ MHz
Reverse voltage	min.	V_{R}	6	6	6	6	6	v	$I_R = 100 \mu A$
Thermal resistance	typ.	θ_{JL}	150	150	150	150	150	°C/W/ LED chip	

					HLMP				TEST
PARAMETER		SYMBOL	-2500	-2550	-2855	-2870	-2885	UNIT	CONDITIONS
Luminous	min.		5	11	11	11	22	mcd	I _F =20 mA
Intensity	typ.	I_{v}	25	50	50	50	100	mcd	$I_F=20 \text{ mA}$
intensity	typ.		38	75	75	75	150	mcd	$I_F = 60 \text{ mA pK}, 1:3 \text{ D.F.}$
Forward	max.	$V_{\scriptscriptstyle F}$	2.6	2.6	2.6	2.6	2.6	.,	I₅=20 mA
voltage	typ.	VF	2.2	2.2	2.2	2.2	2.2	٧	I _F =20 MA
Peak wavelength	typ.	$\lambda_{\mathfrak{p}}$	565	565	565	565	565	nm	
Dominant wavelength	typ.	$\lambda_{\scriptscriptstyle d}$	567	567	567	567	567	nm	
Capacitance	typ.	С	40	40	40	40	40	pF	$V_F = 0$, $f = 1$ MHz
Reverse voltage	min.	$V_{\scriptscriptstyle R}$	6	6	6	6	6	V	$I_R = 100 \mu A$
Thermal resistance	typ.	θ_{JL}	150	150	150	150	150	°C/W/ LED chip	

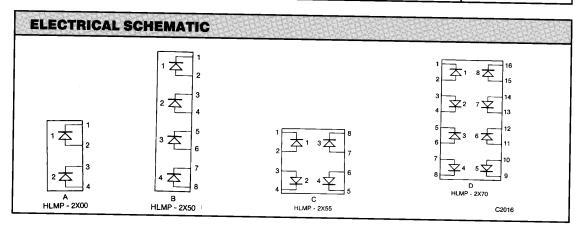








PIN	ELECTRICAL CONNECTION								
	HLMP-2X00	HLMP-2X50	HLMP-2X55	HLMP-2X70/-2X85					
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16	1 Cathode 1 Anode 2 Cathode 2 Anode	1 Cathode 1 Anode 2 Cathode 2 Anode 3 Cathode 3 Anode 4 Cathode 4 Anode	1 Cathode 1 Anode 2 Anode 2 Cathode 3 Cathode 3 Anode 4 Anode 4 Cathode	1 Cathode 1 Anode 2 Anode 2 Cathode 3 Cathode 3 Anode 4 Anode 4 Cathode 5 Cathode 5 Anode 6 Anode 6 Cathode 7 Cathode 7 Anode 8 Anode					





LED LIGHT BARS

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